



2N7002DW

#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C		
60V	$7.5\Omega$ @ $V_{GS} = 5V$	0.23A		

### **Description**

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(ON)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

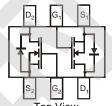
- Motor Control
- Power Management Functions

### **Features**

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 5)

### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



Top View
Internal Schematic

#### **SOT363**



Top View

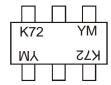
## Ordering Information (Note 6)

Part Number	Compliance	Case	Packaging
2N7002DW-7-F	Standard	SOT363	3,000/Tape & Reel
2N7002DWQ-7-F	Automotive	SOT363	3,000/Tape & Reel
2N7002DW-13-F	Standard	SOT363	10,000/Tape & Reel
2N7002DWQ-13-F	Automotive	SOT363	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http:// /quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https:///quality/product-compliance-definitions/.6. For packaging details, go to our website at https:///design/support/packaging/diodes-packaging/.

### **Marking Information**



 $\begin{array}{l} \text{K72} = \text{Product Type Marking Code} \\ \text{YM or } \overline{\text{Y}}\text{M} = \text{Date Code Marking} \\ \text{Y or } \overline{\text{Y}} = \text{Year (ex: E} = 2017) \\ \text{M} = \text{Month (ex: 9} = \text{September)} \end{array}$ 

Date Code Key

- 410 0040	,														
Year	1998	1999	2000	2001	2002	2003	2004		2017	2018	2019	2020	2021	2022	2023
Code	J	K	L	М	N	Р	R		Е	F	G	Н	ı	J	K
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Ос	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D

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Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			$V_{DSS}$	60	V
Drain-Gate Voltage $R_{GS} \le 1.0 M\Omega$		$V_{DGR}$	60	V	
Cata Cauraa Valtaria		Continuous	$V_{GSS}$	±20	V
Gate-Source Voltage	Pulsed		$V_{GSS}$	±40	V
Continuous Drain Current (Note 8) V <sub>GS</sub> = 5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ $T_A = +100^{\circ}C$	I <sub>D</sub>	0.23 0.18 0.14	А
Maximum Continuous Body Diode Forward Current	(Note 8)	Is	0.53	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	5)	I <sub>DM</sub>	0.8	А	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
	$T_A = +25^{\circ}C$		0.31	
Total Power Dissipation (Note 7)	$T_A = +70$ °C	PD	0.2	W
	$T_A = +100^{\circ}C$		0.12	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{ heta JA}$	410	°C/W
	T <sub>A</sub> = +25°C		0.4	
Total Power Dissipation (Note 8)	$T_A = +70$ °C	P <sub>D</sub>	0.25	W
	T <sub>A</sub> = +100°C		0.15	
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	$R_{\theta JA}$	318	°C/W
Thermal Resistance, Junction to Case (Note 8)	Steady State	$R_{ heta JC}$	135	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

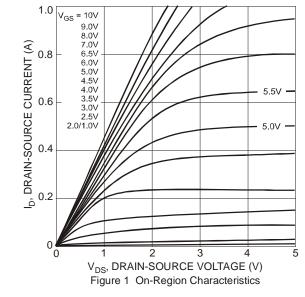
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	60	70	_	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	@ $T_C = +25^{\circ}C$ @ $T_C = +125^{\circ}C$	I <sub>DSS</sub>	l	_	1.0 500	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage		I <sub>GSS</sub>		_	±10	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	1.0	_	2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	@ T <sub>J</sub> = +25°C	R <sub>DS(ON)</sub>	_	3.2 4.4	7.5 13.5	Ω	$V_{GS} = 5.0V, I_D = 0.05A$
	@ T <sub>J</sub> = +125°C		0.5		13.3		$V_{GS} = 10V, I_D = 0.5A$
On-State Drain Current		I <sub>D(ON)</sub>	0.5	1.0	_	Α	$V_{GS} = 10V, V_{DS} = 7.5V$
Forward Transconductance		<b>g</b> FS	80	_	_	mS	$V_{DS} = 10V, I_{D} = 0.2A$
Diode Forward Voltage		$V_{SD}$		0.78	1.5	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance		C <sub>iss</sub>		22	50	pF	.,
Output Capacitance	Output Capacitance			11	25	pF	$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance				2.0	5.0	pF	1 = 1.0WI12
SWITCHING CHARACTERISTICS (Note 10)							
Turn-On Delay Time		t <sub>D(ON)</sub>		7.0	20		$V_{DD} = 30V, I_D = 0.2A,$
Turn-Off Delay Time		t <sub>D(OFF)</sub>	_	11.0	20	ns	$R_L = 150\Omega, V_{GEN} = 10V,$ $R_{GEN} = 25\Omega$

Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





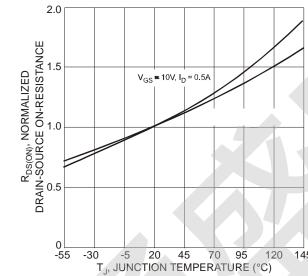
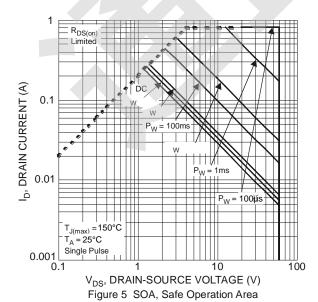
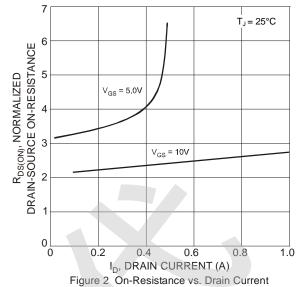
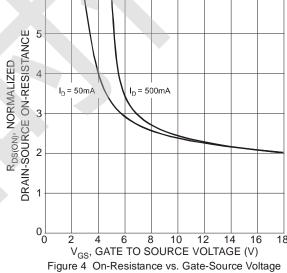


Figure 3 On-Resistance vs. Junction Temperature





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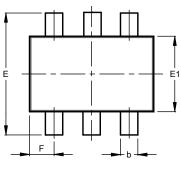


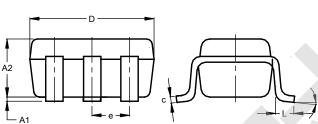


## **Package Outline Dimensions**

Please see http:///package-outlines.html for the latest version.

#### **SOT363**



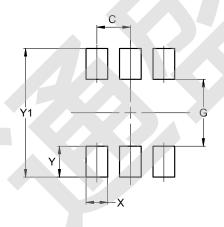


	SOT363							
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	1.00					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
E	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е		0.650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°	-					
All Dimensions in mm								

## **Suggested Pad Layout**

Please see http:///package-outlines.html for the latest version.

### **SOT363**



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
V1	2 500



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